

BRCS5N10MC

Rev.E Apr.-2024

描述 / Descriptions

SOT23-3 塑封封装 N 道场效应管。

N- CHANNEL MOSFET in a SOT23-3 Plastic Package.

特征 / Features

$V_{DS}=100V$ $I_D=5A$

$R_{DS(on)1}@10V \leq 175m\Omega$ (Type.120m Ω)

$R_{DS(on)2}@4.5V \leq 235m\Omega$ (Type.150m Ω)

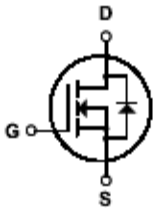
无卤产品。HF Product.

用途 / Applications

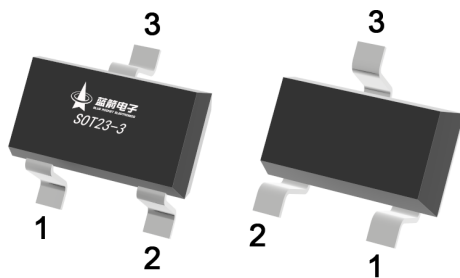
适用电视机等开关电源电路。

Power management in TV Inverter. Power Switch.

内部等效电路 / Equivalent Circuit



引脚排列 / Pinning



PIN1 : G

PIN 2 : S

PIN 3 : D

印章代码 / Marking

Marking	H5N1
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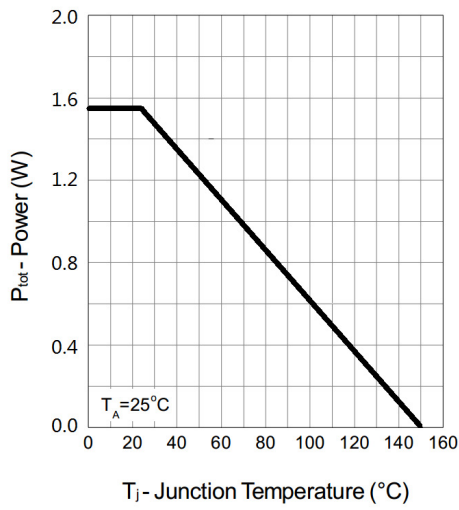
极限参数 / Absolute Maximum Ratings(Ta=25°C)

参数 Parameter	符号 Symbol	数值 Rating	单位 Unit
Drain-Source Voltage	V _{DSS}	100	V
Gate-Source Voltage	V _{GSS}	±20	V
Maximum Drain Current - Continuous	I _D	5.0	A
Drain Current- Pulsed	I _{DM}	15	A
Power Dissipation	P _D	1.55	W
Maximum Junction Temperature	T _J	150	°C
Storage Temperature Range	T _{STG}	-55 to 150	°C
Maximum Resistance –Junction to Ambient	R _{θJA}	80.7	°C/W

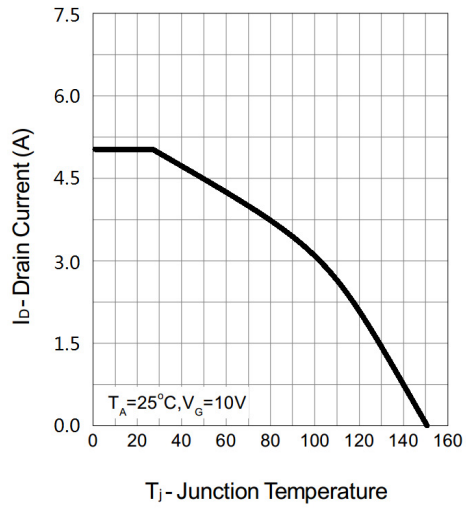
电性能参数 / Electrical Characteristics(Ta=25°C)

参数 Parameter	符号 Symbol	测试条件 Test Conditions	最小值 Min	典型值 Typ	最大值 Max	单位 Unit
Drain–Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _{DS} =250μA	100			V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =100V V _{GS} =0V			1	μA
Gate–Body Leakage.	I _{GSS}	V _{GS} =±20V V _{DS} =0V			±10	μA
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} I _{DS} =250μA	1		3	V
Static Drain–Source On–Resistance	R _{DS(on)(1)}	V _{GS} =10V I _D =5A		120	175	mΩ
	R _{DS(on)(2)}	V _{GS} =4.5V I _D =2A		150	235	mΩ
Drain-Source Diode Forward Voltage	V _{SD}	V _{GS} =0V I _F =1A			1.3	V
Input Capacitance	C _{iss}	V _{DS} =0V V _{GS} =25V f=1.0MHz		200		pF
Output Capacitance	C _{oss}			150		pF
Reverse Transfer Capacitance	C _{rss}			30		pF
Turn–On Delay Time	t _{d(on)}	I _{DS} =1A V _{GEN} =10V V _{DD} =30V R _L =30Ω R _G =6Ω		11		ns
Turn–On Rise Time	t _r			10		ns
Turn–Off Delay Time	t _{d(off)}			21		ns
Turn–Off Fall Time	t _f			5		ns
Total Gate Charge	Q _g	V _{DS} =50V V _{GS} =10V I _{DS} =5A		9.5		nC
Gate- Source Charge	Q _{gs}			1.9		nC
Gate- Drain Charge	Q _{gd}			2.1		nC

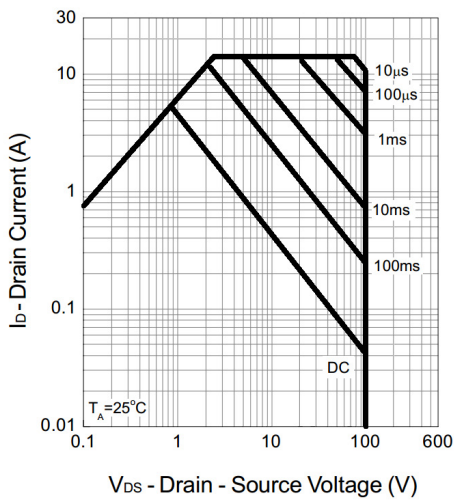
电参数曲线图 / Electrical Characteristic Curve



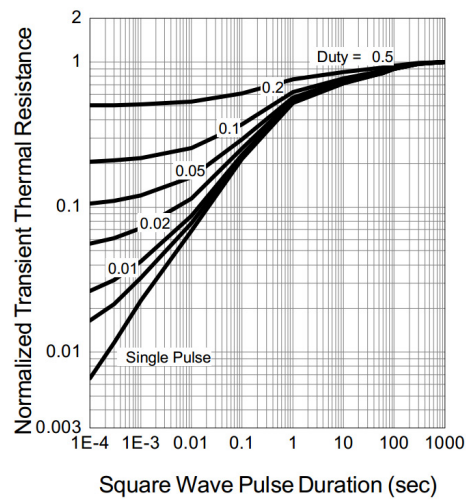
Power Dissipation



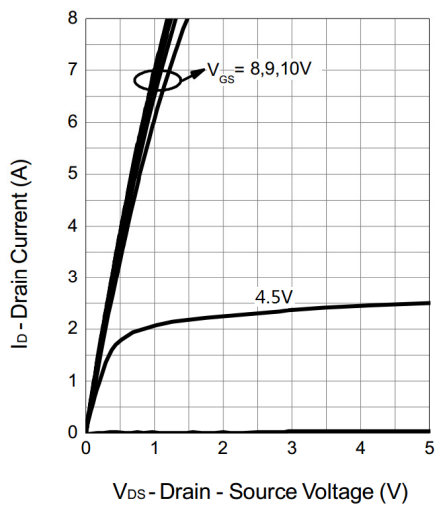
Drain Current



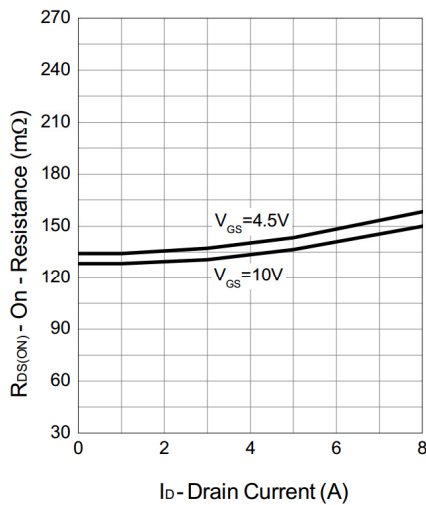
Safe Operation Area



Thermal Transient Impedance

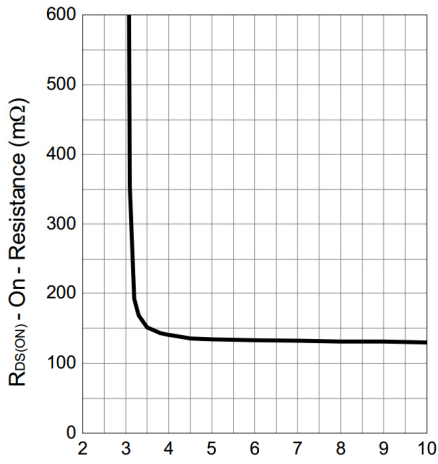


Output Characteristics

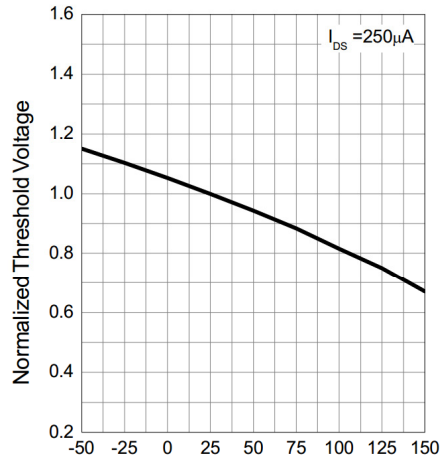


Drain-Source On Resistance

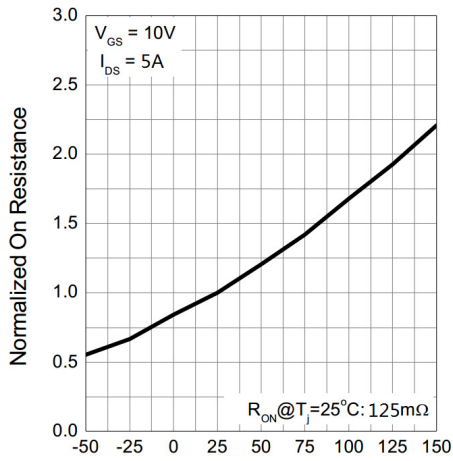
电参数曲线图 / Electrical Characteristic Curve



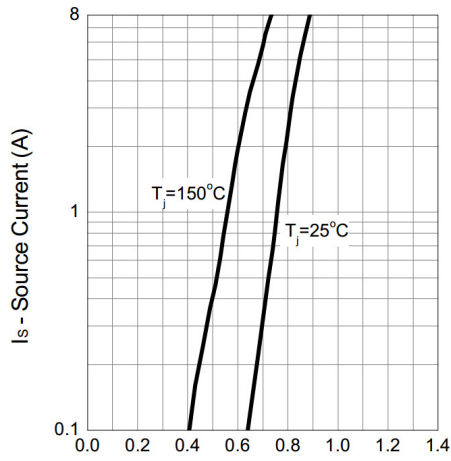
V_{GS} - Gate - Source Voltage (V)
Gate-Source On Resistance



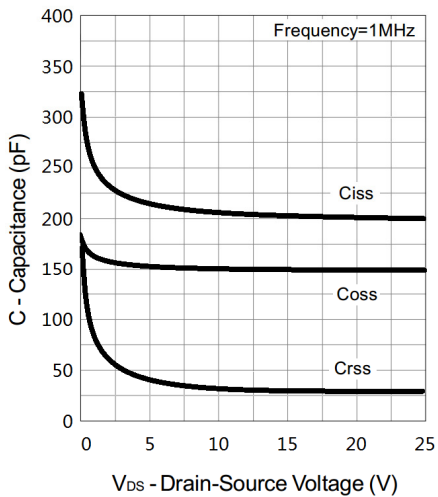
T_J - Junction Temperature (°C)
Gate Threshold Voltage



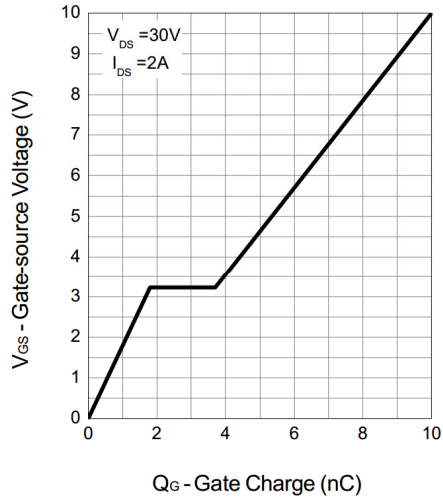
T_J - Junction Temperature (°C)
Drain-Source On Resistance



V_{SD} - Source - Drain Voltage (V)
Source-Drain Diode Forward

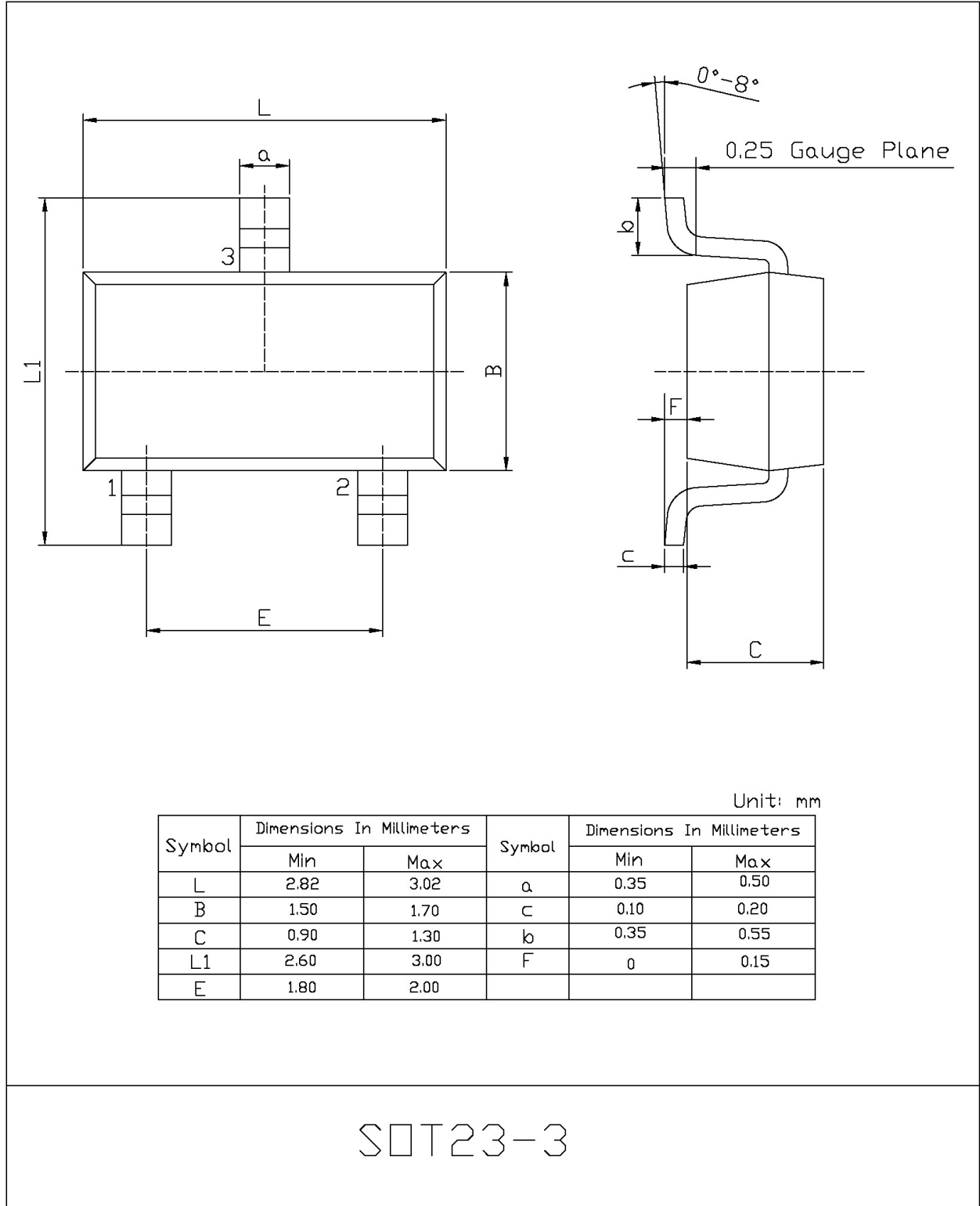


Capacitance

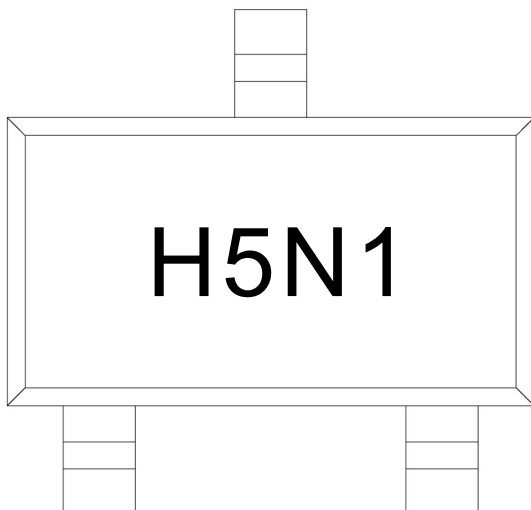


Gate Charge

外形尺寸图 / Package Dimensions



印章说明 / Marking Instructions



说明：

H: 为公司代码

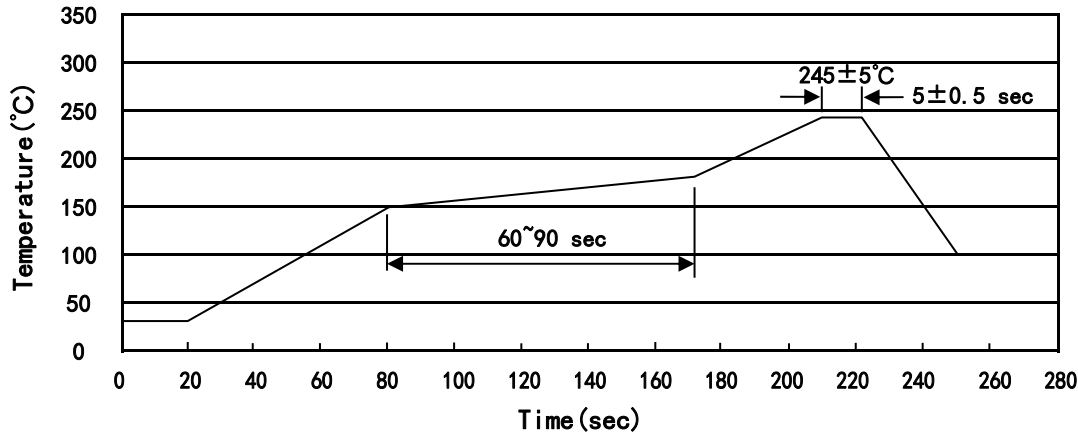
5N1：为型号代码

Note:

H：Company Code

5N1: Product Type Code

回流焊温度曲线图(无铅) / Temperature Profile for IR Reflow Soldering(Pb-Free)



说明：

- 1、预热温度 150~180°C，时间 60~90sec;
- 2、峰值温度 245±5°C，时间持续为 5±0.5sec;
- 3、焊接制程冷却速度为 2~10°C/sec.

Note:

- 1.Preheating:150~180°C, Time:60~90sec.
- 2.Peak Temp.:245±5°C, Duration:5±0.5sec.
3. Cooling Speed: 2~10°C/sec.

耐焊接热试验条件 / Resistance to Soldering Heat Test Conditions

温度：260±5°C

时间：10±1 sec.

Temp.:260±5°C

Time:10±1 sec

包装规格 / Packaging SPEC.

卷盘包装 / REEL

Package Type 封装形式	Units 包装数量					Dimension 包装尺寸 (unit: mm ³)		
	Units/Reel 只/卷盘	Reels/Inner Box 卷盘/盒	Units/Inner Box 只/盒	Inner Boxes/Outer Box 盒/箱	Units/Outer Box 只/箱	Reel	Inner Box 盒	Outer Box 箱
SOT23-3	3,000	10	30,000	4	120,000	7" ×8	210×205×205	445×435×230

使用说明 / Notices